



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
60V	2Ω @ V _{GS} = 10V	380mA
00 V	3Ω @ V _{GS} = 5V	310mA

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Motor Control
- Power Management Functions
- Backlighting

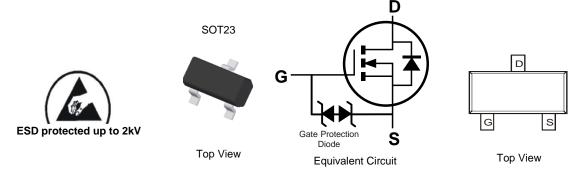
Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Up To 2kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The 2N7002KQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.008 grams (Approximate)



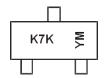
Ordering Information (Note 4)

Part Number	Case	Packaging
2N7002KQ-7	SOT23	3,000/Tape & Reel
2N7002KQ-13	SOT23	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\begin{array}{l} \text{K7K} = \text{Product Type Marking Code} \\ \text{YM} = \text{Date Code Marking} \\ \text{Y or } \overline{\text{Y}} = \text{Year (ex: I} = 2021) \\ \text{M} = \text{Month (ex: 9} = \text{September)} \\ \end{array}$

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	ı	J	K	L	М	N	0	Р	R	S	T	U
Month	lan	Feb	Mar	Anr	May	lun	lul	Aua	Sep	Oct	Nov	Dec
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit		
Drain-Source Voltage		VDSS	60	V		
Gate-Source Voltage			Vgss	±20	V	
Continuous Durin Compant (Nata C) Vac. 40V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	380 300	mA	
Continuous Drain Current (Note 6) V _{GS} = 10V $t < 5s$ $T_A = T_A = T_A$			lo	430 340	mA	
State $T_A = -1$		T _A = +25°C T _A = +70°C	I _D	310 240	mA	
Continuous Drain Current (Note 6) V _{GS} = 5V			lo	350 270	mA	
Maximum Continuous Body Diode Forward Curren	ls	0.5	A			
Pulsed Drain Current (10µs Pulse, Duty Cycle = 19	%) (Note 6	5)	I _{DM}	1.2	А	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	370	mW	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	357	°C/W	
mermal Resistance, Junction to Ambient (Note 5)	t<5s	RөJA	292	C/VV	
Total Power Dissipation (Note 6)		PD	540	mW	
Thermal Registeres, Jungtion to Ambient (Note 6)		Б	240		
Thermal Resistance, Junction to Ambient (Note 6)	t<5s	RөJA	197	°C/W	
Thermal Resistance, Junction to Case (Note 6)		R ₀ JC	91		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

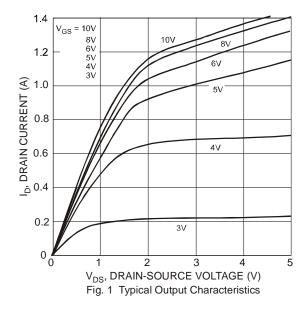
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

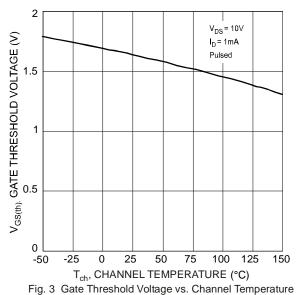
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V, I_{D} = 10\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1.0	μΑ	V _{DS} = 60V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(TH)	1.0	1.6	2.5	V	$V_{DS} = 10V$, $I_D = 1mA$
Static Drain-Source On-Resistance	D- avanu		1.2	2.0	Ω	$V_{GS} = 10V, I_{D} = 0.5A$
Static Dialit-Source Off-Nesistance	R _{DS(ON)}		1.4	3.0	\$2	$V_{GS} = 5V, I_D = 0.05A$
Forward Transfer Admittance	Y _{fs}	80	_	_	ms	V _{DS} =10V, I _D = 0.2A
Diode Forward Voltage	V _{SD}	_	0.75	1.1	V	$V_{GS} = 0V, I_{S} = 115mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	30	50	pF	V 05V V 0V
Output Capacitance	Coss	_	4.2	25	pF	V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	2.9	5.0	pF	1 = 1.0101112
Gate Resistance	Rg	_	133	_	Ω	$f = 1MHz$, $V_{GS} = 0V$, $V_{DS} = 0V$
Total Gate Charge	Qg	_	0.3	_	nC	451/1/ 401/
Gate-Source Charge	Qgs	_	0.2	_	nC	V _G S = 4.5V, V _D S = 10V,
Gate-Drain Charge	Q _{gd}	_	0.08	_	nC	I _D = 250mA
Turn-On Delay Time	t _D (ON)	_	3.9	_	ns	
Turn-On Rise Time	t _R	_	3.4	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$
Turn-Off Delay Time	t _D (OFF)	_	15.7	_	ns	$R_G = 25\Omega$, $I_D = 200 \text{mA}$
Turn-Off Fall Time	tF	_	9.9	_	ns	

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

- 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.







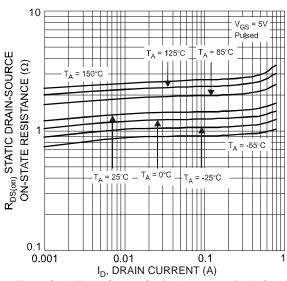
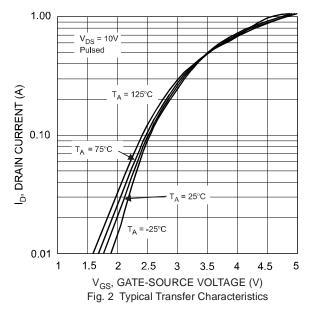


Fig. 5 Static Drain-Source On-Resistance vs. Drain Current



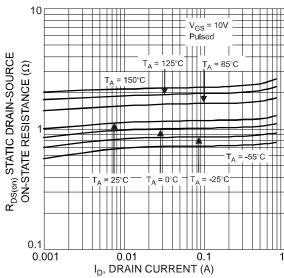


Fig. 4 Static Drain-Source On-Resistance vs. Drain Current

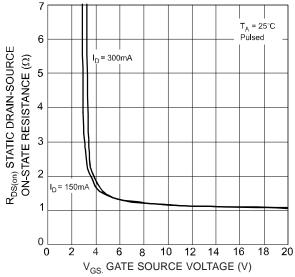


Fig. 6 Static Drain-Source On-Resistance vs. Gate-Source Voltage



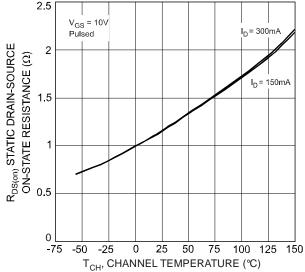


Fig. 7 Static Drain-Source On-State Resistance vs. Channel Temperature

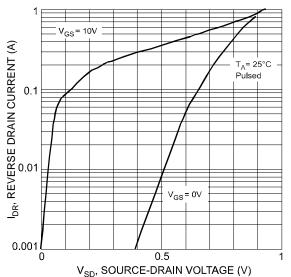
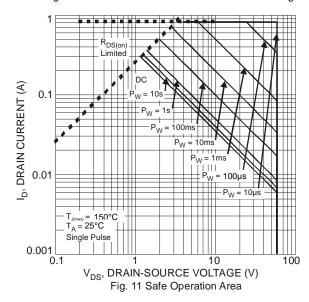
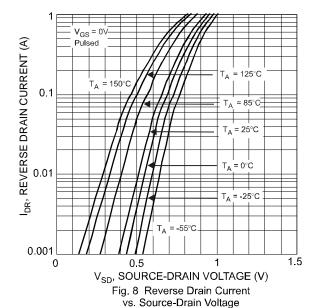


Fig. 9 Reverse Drain Current vs. Source-Drain Voltage





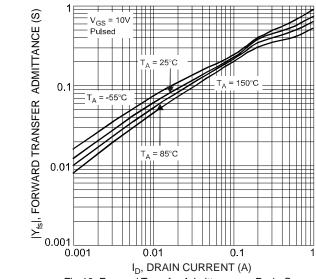


Fig.10 Forward Transfer Admittance vs. Drain Current

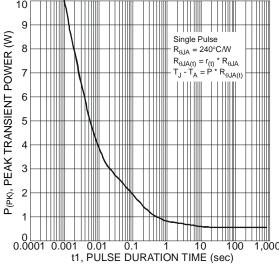
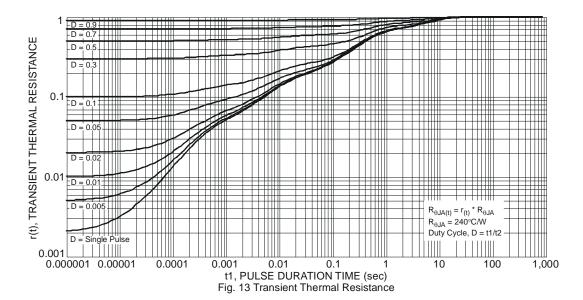


Fig. 12 Single Pulse Maximum Power Dissipation



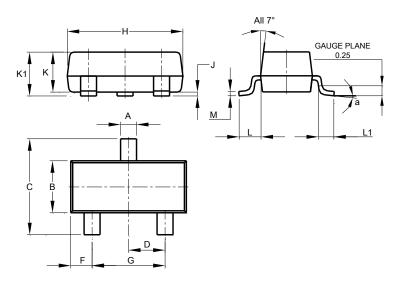




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

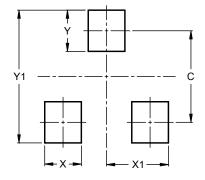


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
C	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
H	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
M	0.085	0.150	0.110				
а	0°	8°					
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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